# **ON Semiconductor**

# Is Now



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**Preferred Devices** 

# **Axial Lead Rectifiers**

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- High Current Capability
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency
- Highly Stable Oxide Passivated Junction
- Guard-Ring for Stress Protection
- Low Forward Voltage
- High Surge Capacity

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 500 per bag
- Available Tape and Reeled, 1500 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode indicated by Polarity Band
- ESD Protection: Human Body Model > 4000 V (Class 3)

  Model > 400 V (Class C)

#### **MAXIMUM RATINGS**

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>		٧
MBR835 MBR840 MBR845	PE	35 40 45	
Average Rectified Forward Current  T <sub>L</sub> = 75°C (Psi <sub>JL</sub> = 12°C/W, P.C. Board Mounting, see Note 2)	lo	8.0	Α
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	140	A
Operating and Storage Junction Temperature Range (Reverse Voltage Applied)	T <sub>J</sub> , T <sub>stg</sub>	-65 to +125	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10	V/ns

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#### ON Semiconductor™

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# SCHOTTKY BARRIER RECTIFIERS 8.0 AMPERES



AXIAL LEAD CASE 267-05 (DO-201AD) STYLE 1

#### **MARKING DIAGRAM**



MBR8xx = Device Codexx = 35, 40 or 45

#### **ORDERING INFORMATION**

Device	Package	Shipping	
MBR835	Axial Lead	500 Units/Bag	
MBR835RL	Axial Lead 1500/Tape & Red		
MBR840	Axial Lead	xial Lead 500 Units/Bag	
MBR840RL	Axial Lead	1500/Tape & Reel	
MBR845	Axial Lead	500 Units/Bag	
MBR845RL	Axial Lead	1500/Tape & Reel	

**Preferred** devices are recommended choices for future use and best overall value.

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	0.9 in x 0.9 in Copper Pad Size	6.75 in x 6.75 in Copper Pad Size	Unit
Thermal Resistance – Junction-to-Lead (See Note 2 – Mounting Data)	$R_{ heta JL}$	13	12	°C/W
Thermal Resistance – Junction-to-Ambient (See Note 2 – Mounting Data)	$R_{\theta JA}$	50	40	

#### **ELECTRICAL CHARACTERISTICS** (T<sub>L</sub> = 25°C unless otherwise noted)

Characteristic			Max	Unit
Maximum Instantaneous Forward Voltage (Note 1) (i <sub>F</sub> = 8.0 Amps, T <sub>L</sub> = 25°C)		٧F	0.55	V
Maximum Instantaneous Reverse Current @ Rated dc Voltage (Note 1) $T_L = 25^{\circ}C$ $T_L = 100^{\circ}C$		i <sub>R</sub>	1.0 50	mA

<sup>1.</sup> Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle =[2.0%.

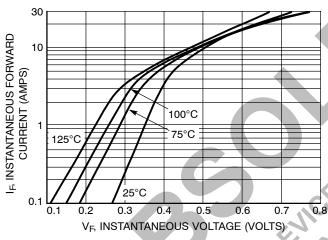


Figure 1. Typical Forward Voltage

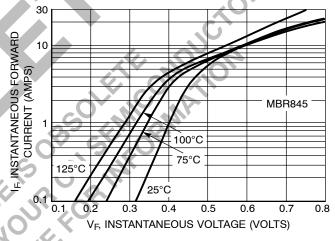


Figure 2. Maximum Forward Voltage

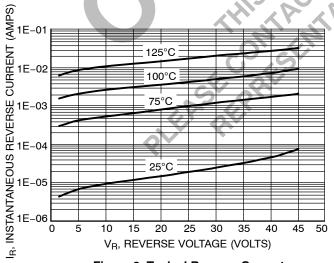


Figure 3. Typical Reverse Current

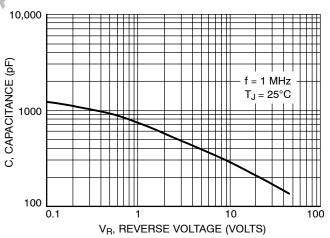


Figure 4. Typical Capacitance

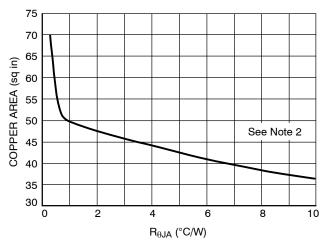


Figure 5.  $R_{\theta JA}$  versus Copper Area

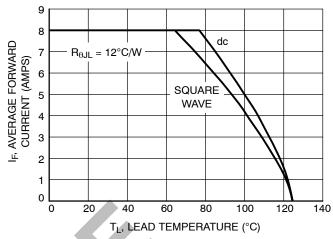


Figure 6. Current Derating - Lead

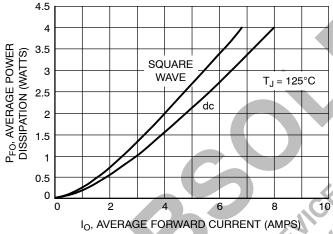
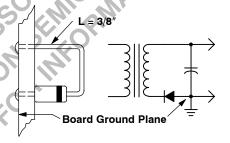


Figure 7. Forward Power Dissipation

### NOTE 2 — MOUNTING DATA

#### **Mounting Method**

P.C. Board with 6.75 sq. in. copper surface.



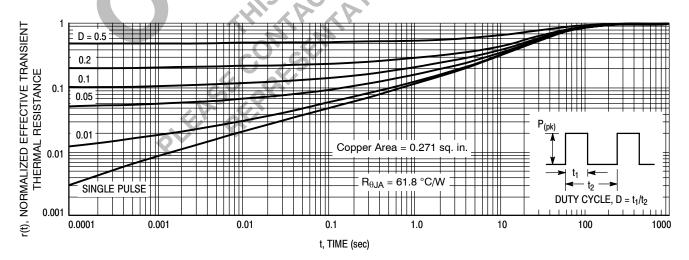
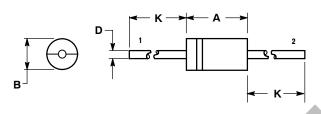


Figure 8. Thermal Response, Junction-to-Ambient

#### PACKAGE DIMENSIONS

## **AXIAL LEAD**

CASE 267-05 (DO-201AD) ISSUE G



- DIMENSIONING AND TOLERANCING PER ANSI
- 2. CONTROLLING DIMENSION: INCH.

		INCHES		MILLIMETERS		
	DIM	MIN	MAX	MIN	MAX	
1	A	0.287	0.374	7.30	9.50	
Į	В	0.189	0.209	4.80	5.30	
	D	0.047	0.051	1.20	1.30	
	K	1.000		25.40		

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